



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	IPD80R1K4CE	<b>Issued</b>	12. August 2021
<b>MA#</b>	MA005619459		
<b>Package</b>	PG-TO252-3-341	<b>Weight*</b>	389.84 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.894	1.00	1.00	9988	9988
leadframe	inorganic material	phosphorus	7723-14-0	0.069	0.02		176	
	non noble metal	iron	7439-89-6	0.229	0.06		588	
	non noble metal	copper	7440-50-8	228.946	58.73	58.81	587277	588041
wire	non noble metal	aluminium	7429-90-5	0.516	0.13	0.13	1324	1324
encapsulation	organic material	carbon black	1333-86-4	0.388	0.10		995	
	plastics	epoxy resin	-	11.771	3.02		30195	
	inorganic material	silicondioxide	60676-86-0	117.197	30.06	33.18	300627	331817
leadfinish	non noble metal	tin	7440-31-5	3.740	0.96	0.96	9594	9594
plating	non noble metal	nickel	7440-02-0	0.509	0.13	0.13	1305	1305
solder	non noble metal	tin	7440-31-5	0.068	0.02		173	
	noble metal	silver	7440-22-4	0.085	0.02		217	
	non noble metal	lead	7439-92-1	3.229	0.83	0.87	8284	8674
heatspreader	inorganic material	phosphorus	7723-14-0	0.006			15	
	non noble metal	iron	7439-89-6	0.019			49	
	non noble metal	copper	7440-50-8	19.177	4.92	4.92	49193	49257
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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